CLAIMS

What is Claimed is:

- 1-11. (Canceled)
- (Original) A method for forming group III-N based articles, comprising the steps of: 12. providing a single crystal silicon substrate; depositing a single crystal zinc oxide (ZnO) layer on said substrate, and depositing a single crystal group III-N layer on said ZnO layer, wherein at least a portion of said step of depositing group III-N layer is performed at a temperature of less than 600° C.
- (Original) The method of claim 12, wherein said step of depositing said group III-N 13. layer comprises depositing a seed layer at a temperature of no more than 600° C, followed by a step of depositing another portion of said group III-N layer at a temperature of more than 600° C.
- (Original) The method of claim 12, further comprising the step of treating said ZnO layer 14. with a gallium comprising gas before said step of depositing said group III-N layer.
- (Original) The method of claim 14, wherein said gallium comprising gas comprises 15. triethyl gallium.
- (Original) The method of claim 12, wherein said group III-N layer comprises GaN. 16.

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- 17. (Original) The method of claim 12, wherein said group III-N layer is an epitaxial layer.
- 18. (Original) The method of claim 12, wherein a thickness of said ZnO layer is less than 200 angstroms.
- 19. (Original) The method of claim 12, wherein said step of depositing a zinc oxide (ZnO) layer comprises pulsed laser deposition.